

Product Summary

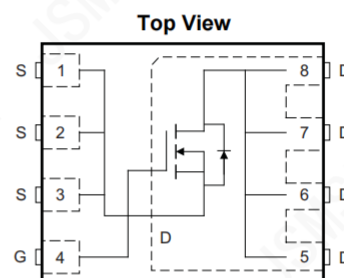
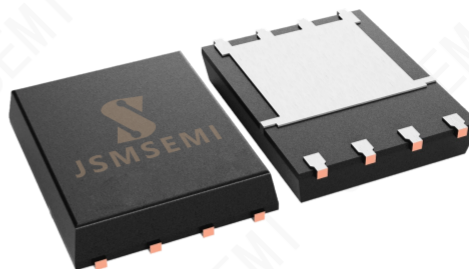
- V_{DS} 40V
- I_D 150A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) $<1.4m\Omega$
- $R_{DS(ON)}$ (at $V_{GS}=4.5V$) $<2.6m\Omega$
- 100% EAS Tested
- 100% ∇V_{DS} Tested

General Description

- Split gate trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Power switching application
- Uninterruptible power supply
- DC-DC convertor



■ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	40	V
Gate-source Voltage		V_{GS}	± 20	V
Drain Current	$T_A=25^\circ\text{C}$	I_D	60	A
	$T_A=100^\circ\text{C}$		25	
	$T_C=25^\circ\text{C}$		150	
	$T_C=100^\circ\text{C}$		110	
Pulsed Drain Current ^A		I_{DM}	600	A
Avalanche energy ^B		EAS	450	mJ
Total Power Dissipation ^C	$T_A=25^\circ\text{C}$	P_D	2.2	W
	$T_A=100^\circ\text{C}$		0.9	
	$T_C=25^\circ\text{C}$		114	
Junction and Storage Temperature Range		T_J, T_{STG}	$-55 \sim +150$	$^\circ\text{C}$

■ Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient ^D	Steady-State	$R_{\theta JA}$	45	55	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	1.0	1.1	

■ Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =250μA	40	-	-	V
		V _{GS} = 0V, I _D =1mA	40	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V, V _{GS} =0V	-	-	1	μA
		V _{DS} =40V, V _{GS} =0V, T _j =150°C	-	-	100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	1.3	1.7	2.3	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D =50A	-	1.1	1.4	mΩ
		V _{GS} =4.5V, I _D =25A	-	1.7	2.6	
Diode Forward Voltage	V _{SD}	I _S =50A, V _{GS} =0V	-	-	1.2	V
Gate resistance	R _G	f=1MHz	-	3.5	-	Ω
Maximum Body-Diode Continuous Current	I _S		-	-	170	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =20V, V _{GS} =0V, f=1MHz	-	5500	-	pF
Output Capacitance	C _{oss}		-	1850	-	
Reverse Transfer Capacitance	C _{rss}		-	65	-	
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =10V, V _{DS} =20V, I _D =50A	-	87	-	nC
Gate-Source Charge	Q _{gs}		-	18	-	
Gate-Drain Charge	Q _{gd}		-	15	-	
Reverse Recovery Charge	Q _{rr}	I _F =50A, di/dt=100A/us	-	53	-	nC
Reverse Recovery Time	t _{rr}		-	55	-	ns
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DD} =20V, I _D =50A R _{GEN} =3Ω	-	14	-	ns
Turn-on Rise Time	t _r		-	15	-	
Turn-off Delay Time	t _{D(off)}		-	84	-	
Turn-off fall Time	t _f		-	44	-	

A. Repetitive rating; pulse width limited by max. junction temperature.

 B. $T_J=25^{\circ}\text{C}$, $V_G=10\text{V}$, $R_G=25\Omega$, $L=0.5\text{mH}$

 C. P_d is based on max. junction temperature, using junction-case and junction-ambient thermal resistance.

■ Typical Electrical and Thermal Characteristics Diagrams

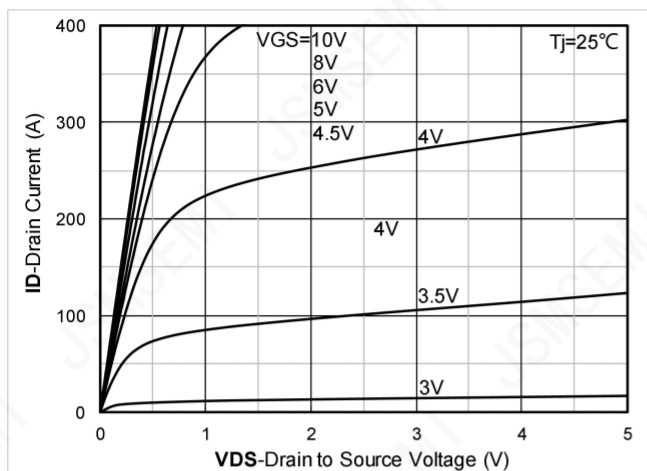


Figure 1. Output Characteristics

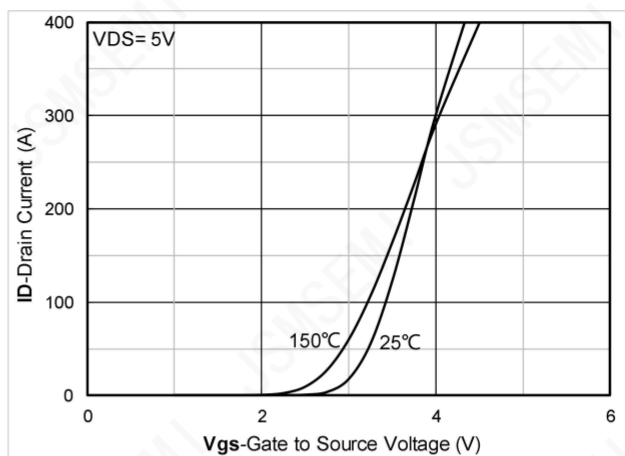


Figure 2. Transfer Characteristics

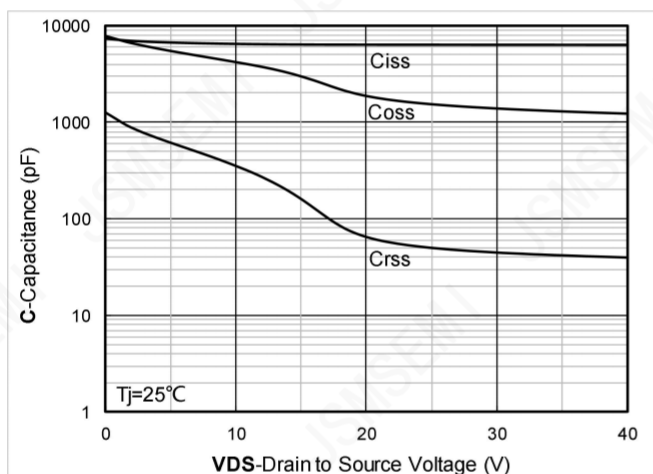


Figure 3. Capacitance Characteristics

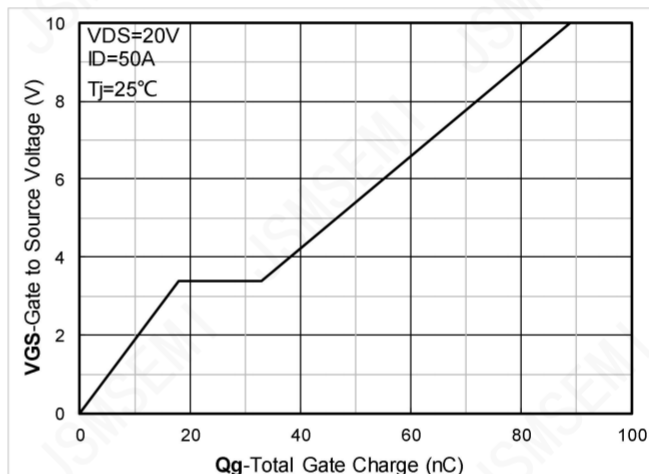


Figure 4. Gate Charge

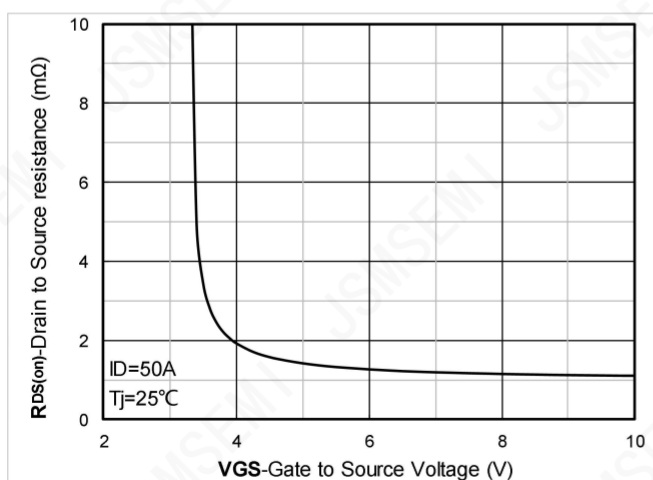


Figure 5. On-Resistance vs Gate to Source Voltage

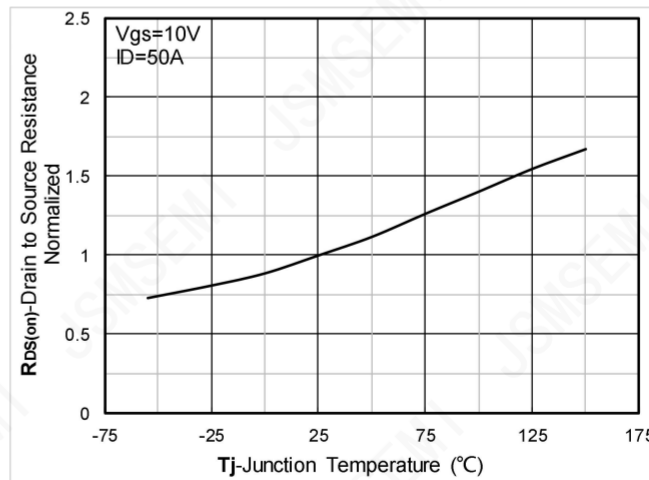


Figure 6. Normalized On-Resistance

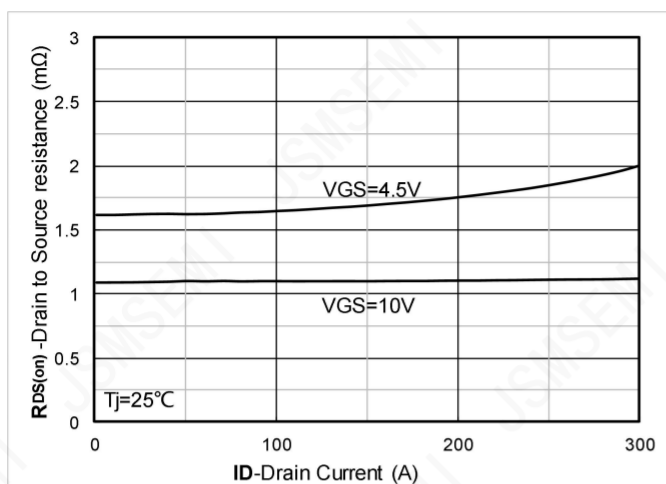


Figure 7. $R_{DS(on)}$ VS Drain Current

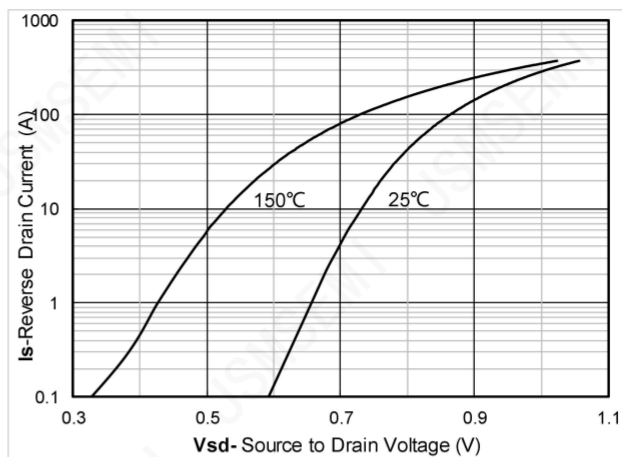


Figure 8. Forward characteristics of reverse diode

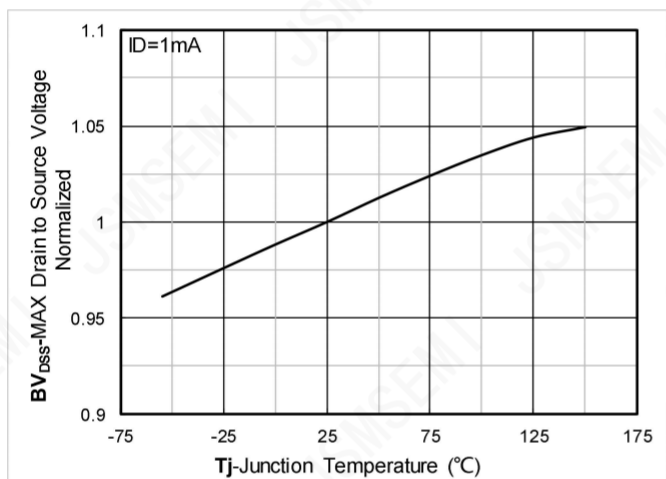


Figure 9. Normalized breakdown voltage

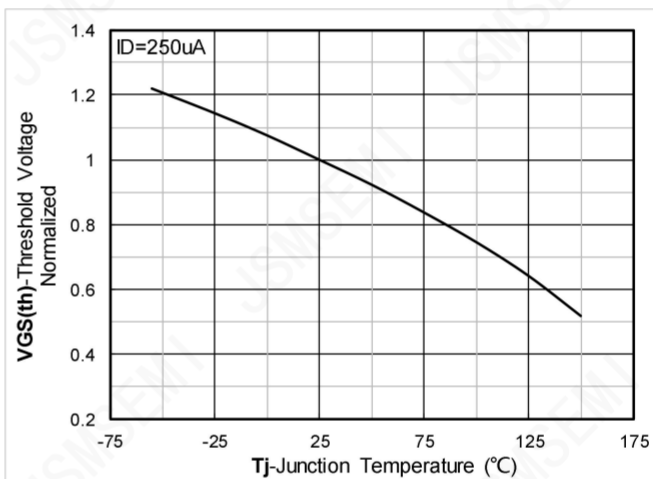


Figure 10. Normalized Threshold voltage

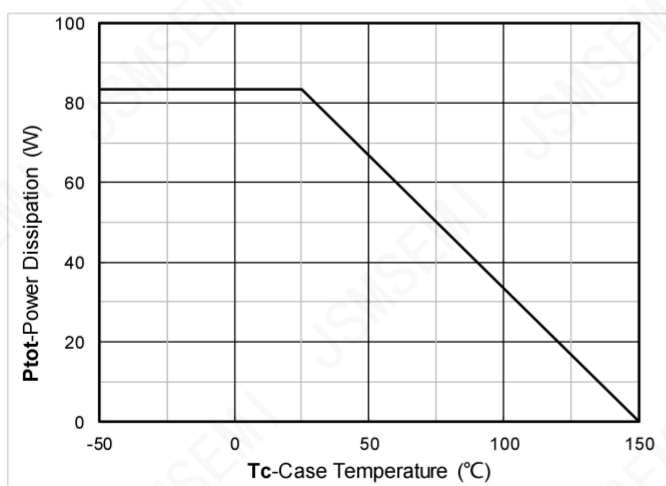


Figure 11. Power dissipation

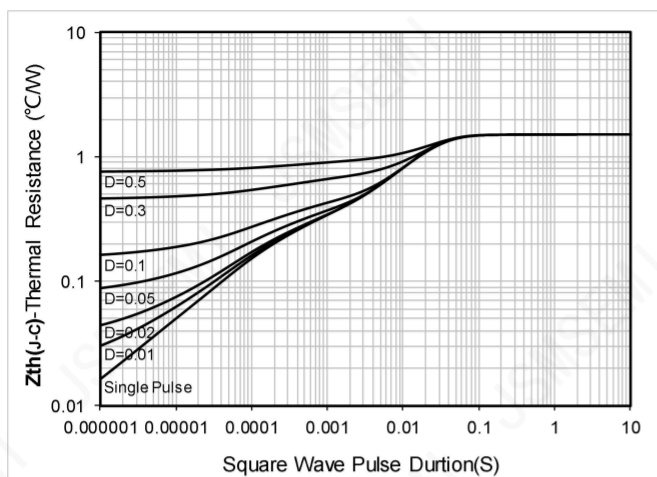


Figure 12. Maximum Transient Thermal Impedance

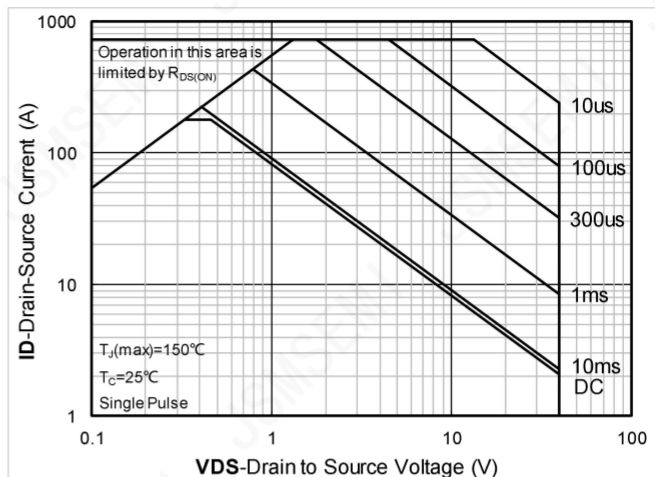


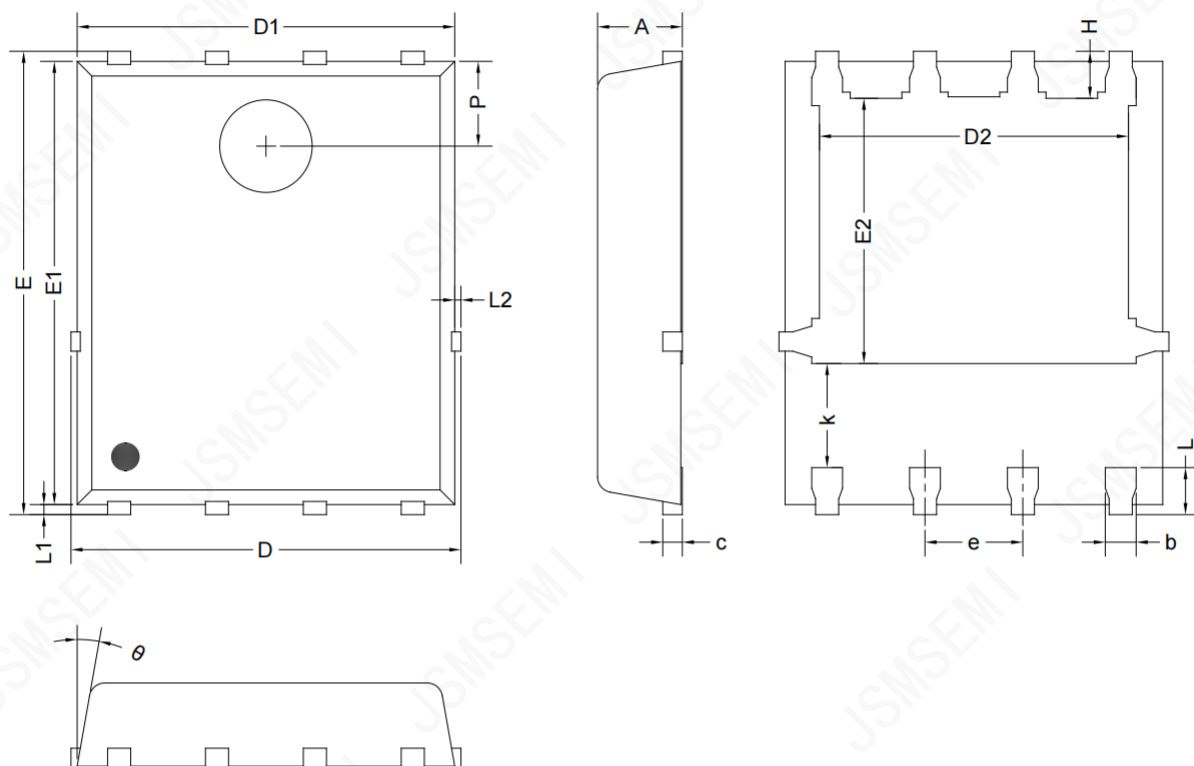
Figure 13. Safe Operation Area

Ordering Information

Order number	Package	Marking	Operation Temperature Range	MSL Grade	Ship,Quantity	Green
SHYG015N04LS1C2	DFN5060-8L	014N04QG5	-55 to 150°C	1	T&R,5000	RoHS

Package Information

PDFN5060-8L



Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	1.000	1.100	1.200
b	0.350	0.400	0.450
c	0.210	0.250	0.340
D	4.800	-	5.100
D1	4.800	4.900	5.000
D2	3.910	4.010	4.110
E	5.900	6.000	6.100
E1	5.700	5.750	5.800
E2	3.340	3.440	3.540
e	1.270 BSC		
H	0.510	0.610	0.710
k	1.100	-	-
L	0.510	0.610	0.710
L1	0.060	0.130	0.200
L2	-	-	0.100
P	1.000	1.100	1.200
θ	8°	10°	12°

NOTE: This drawing is subject to change without notice.